imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Inductors for Power Circuits

Wound Metal

VLS-HBX-1 Series

VLS01612HBX-1 Туре

VLS201612HBX-1



REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

▲ REMINDERS ○ The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity: 10 to 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate. O Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.). O Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperature does not exceed 150°C. O Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur. O When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions. Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design. Carefully lay out the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference. ○ Use a wrist band to discharge static electricity in your body through the grounding wire. O Do not expose the products to magnets or magnetic fields. O Do not use for a purpose outside of the contents regulated in the delivery specifications. O The products listed on this catalog are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. If you intend to use the products in the applications listed below or if you have special requirements exceeding the range or conditions set forth in the each catalog, please contact us. (1) Aerospace/Aviation equipment (8) Public information-processing equipment (2) Transportation equipment (cars, electric trains, ships, etc.) (9) Military equipment (3) Medical equipment (10) Electric heating apparatus, burning equipment (4) Power-generation control equipment (11) Disaster prevention/crime prevention equipment (5) Atomic energy-related equipment (12) Safety equipment (6) Seabed equipment (13) Other applications that are not considered general-purpose applications (7) Transportation control equipment When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.

Inductors for Power Circuits

Wound Metal

Product compatible with RoHS directive Halogen-free Compatible with lead-free solders

Overview of the VLS201612HBX-1 Type

FEATURES

O Magnetic shield type wound inductor for power circuits using a metallic magnetic material.

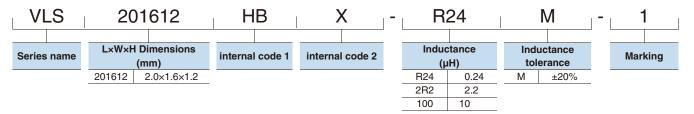
O High magnetic shield construction and compatible with high-density mounting.

O Larger current was achieved by the metallic magnetic material.

APPLICATION

Smart phones, tablet terminals, HDDs, SSDs, DVCs, DSCs, mobile display panels, portable game devices, compact power supply modules, other

PART NUMBER CONSTRUCTION



OPERATING TEMPERATURE RANGE, PACKAGE QUANTITY, PRODUCT WEIGHT

| | Temperat | ure range | Package quantity | Individual weight |
|----------------|---------------------------|--------------------------|------------------|-------------------|
| Туре | Operating temperature* | Storage temperature** | | |
| | (°C) | | (pieces/reel) | (mg) |
| VLS201610HBX-1 | -40 to +105 -40 to +105 | | 2000 | 16 |

* Operating temperature range includes self-temperature rise.

** The Storage temperature range is for after the circuit board is mounted.

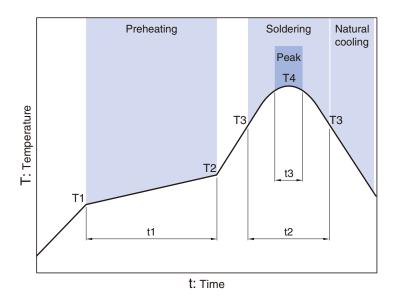
RoHS Directive Compliant Product: See the following for more details related to RoHS Directive compliant products. http://product.tdk.com/en/environment/rohs/
Halogen-free: Indicates that CI content is less than 900ppm, Br content is less than 900ppm, and that the total CI and Br content is less than 1500ppm.

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VLS201612HBX-1 Type

RECOMMENDED REFLOW PROFILE

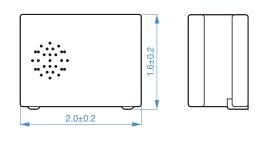


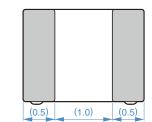
| Preheating | | Soldering | l | Peak | Peak | | |
|------------|-------|------------|-------|------|-------|------|--|
| Temp. | | Time | Temp. | Time | Temp. | Time | |
| T1 | T2 | t1 | Т3 | t2 | T4 | t3 | |
| 150°C | 180°C | 60 to 120s | 230°C | 30s | 260°C | 10s | |

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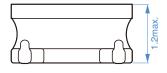
VLS201612HBX-1 Type

SHAPE & DIMENSIONS



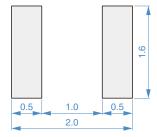






Dimensions in mm

RECOMMENDED LAND PATTERN



Dimensions in mm

VLS201612HBX-1 Type

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS SPECIFICATION TABLE

| L | | L measuring frequency | DC resista | ance | Rated cur | rent* | | Part No. | | |
|------|-----------|--------------------------|-------------------------|-------------------------|-----------|---------|---------|----------|---------------------|--|
| (11) | Telemente | | (0) | (0)tran | Isat | Itemp | Isat | Itemp | | |
| (µH) | Tolerance | (MHz) | (Ω)max. | (Ω)typ. | (A)max. | (A)max. | (A)typ. | (A)typ. | | |
| 0.24 | ±20% | 1 | 0.029 | 0.022 | 5.65 | 4.25 | 6.50 | 5.00 | VLS201612HBX-R24M-1 | |
| 0.33 | ±20% | 1 | 0.035 | 0.028 | 4.34 | 3.87 | 5.00 | 4.55 | VLS201612HBX-R33M-1 | |
| 0.47 | ±20% | 1 | 0.042 | 0.035 | 3.78 | 3.20 | 4.35 | 3.76 | VLS201612HBX-R47M-1 | |
| 0.68 | ±20% | 1 | 0.054 | 0.045 | 3.03 | 2.77 | 3.50 | 3.26 | VLS201612HBX-R68M-1 | |
| 1.0 | ±20% | 1 | 0.071 | 0.059 | 2.70 | 2.42 | 3.10 | 2.85 | VLS201612HBX-1R0M-1 | |
| 1.5 | ±20% | 1 | 0.109 | 0.091 | 2.16 | 1.89 | 2.50 | 2.22 | VLS201612HBX-1R5M-1 | |
| 2.2 | ±20% | 1 | 0.137 | 0.114 | 1.85 | 1.67 | 2.10 | 1.97 | VLS201612HBX-2R2M-1 | |
| 3.3 | ±20% | 1 | 0.209 | 0.174 | 1.38 | 1.33 | 1.60 | 1.57 | VLS201612HBX-3R3M-1 | |
| 4.7 | ±20% | 1 | 0.312 | 0.260 | 1.20 | 1.10 | 1.37 | 1.29 | VLS201612HBX-4R7M-1 | |
| 6.8 | ±20% | 1 | 0.468 | 0.390 | 0.91 | 0.87 | 1.07 | 1.02 | VLS201612HBX-6R8M-1 | |
| 10 | ±20% | 1 | 0.756 | 0.630 | 0.76 | 0.67 | 0.89 | 0.79 | VLS201612HBX-100M-1 | |

* Rated current: smaller value of either Isat or Itemp.

Isat: When based on the inductance change rate (30% below the nominal L value)

Itemp: When based on the temperature increase (Temperature increase of 40°C by self heating)

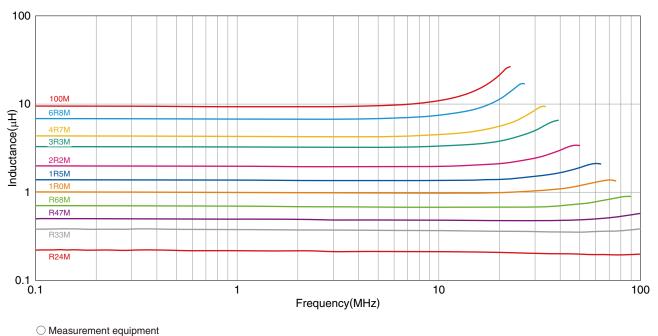
\bigcirc Measurement equipment

| Measurement item | Product No. | Manufacturer |
|--------------------|---------------------|-----------------------|
| L | 4194A | Keysight Technologies |
| DC resistance | VP-2941A | Panasonic |
| Rated current Isat | 4285A+42841A+42842C | Keysight Technologies |

* Equivalent measurement equipment may be used.

ELECTRICAL CHARACTERISTICS

L FREQUENCY CHARACTERISTICS GRAPH



4294A Keysight Technologies * Equivalent measurement equipment may be used.

Manufacturer

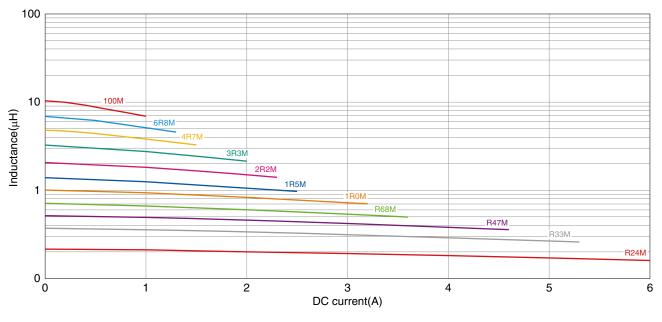
Product No.

A Please be sure to request delivery specifications that provide further details on the features and specifications of the products for proper and safe use. Please note that the contents may change without any prior notice due to reasons such as upgrading.

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ELECTRICAL CHARACTERISTICS

□INDUCTANCE VS. DC BIAS CHARACTERISTICS GRAPH



○ Measurement equipment

Product No. Manufacturer

4285A+42841A+42842C Keysight Technologies

* Equivalent measurement equipment may be used.

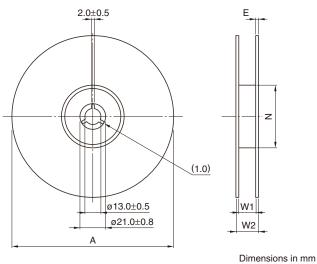
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INDUCTORS

VLS201612HBX-1 Type

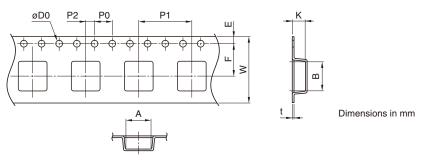




| Туре | А | W1 | W2 | Ν | E |
|----------------|------|----|----|-----|-----|
| VLS201612HBX-1 | ø180 | 9 | 10 | ø60 | 0.5 |

* These values are typical values.

TAPE DIMENSIONS



| Туре | Α | В | øD0 | Е | F | P0 | P1 | P2 | W | K | t |
|----------------|-----|-----|------------|----------|----------|---------|---------|----------|---------|------|------|
| VLS201612HBX-1 | 1.9 | 2.3 | 1.5+0.1/-0 | 1.75±0.1 | 3.5±0.05 | 4.0±0.1 | 4.0±0.1 | 2.0±0.05 | 8.0±0.2 | 1.35 | 0.25 |